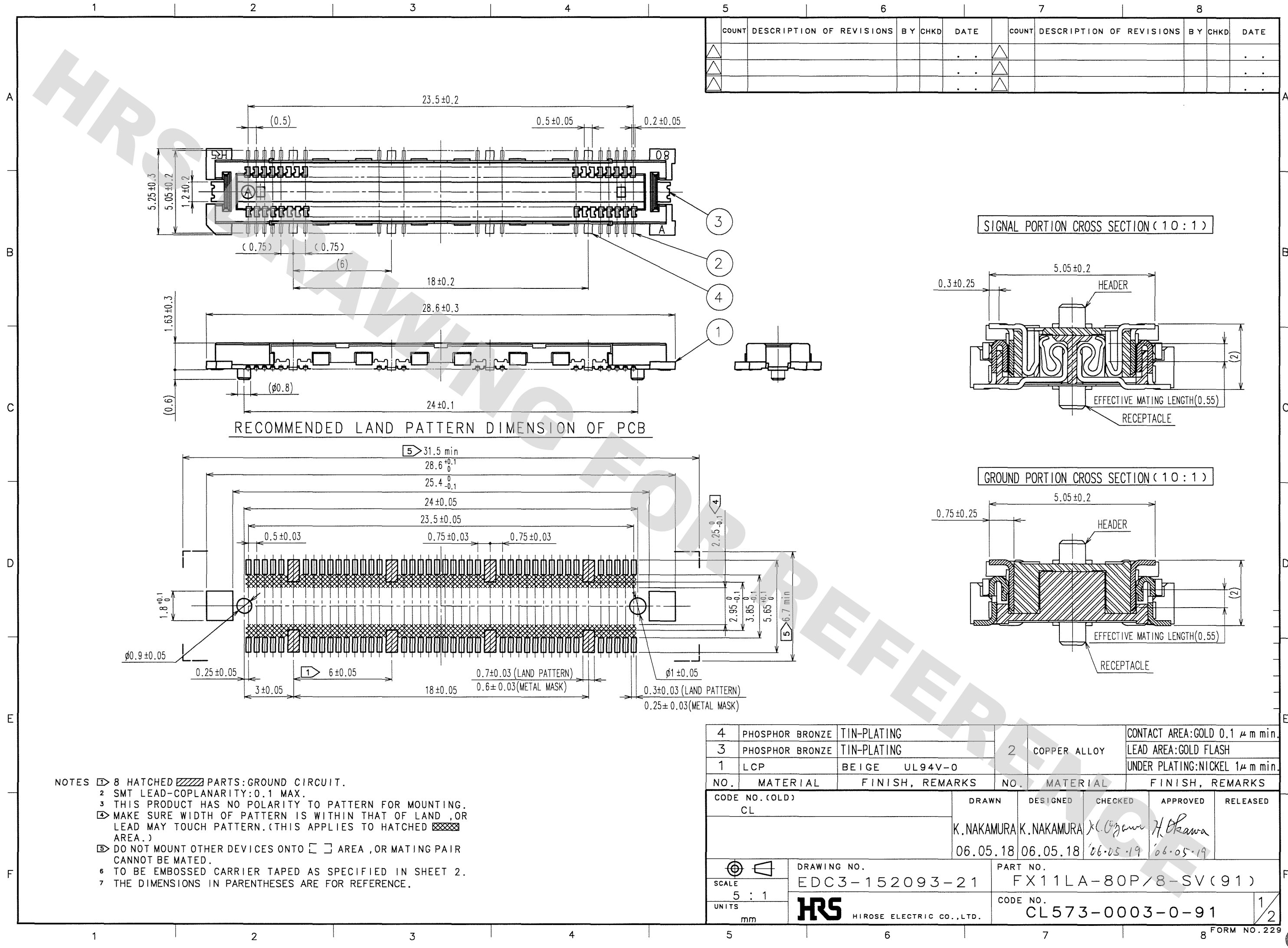


DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012

TO
PCK



- NOTES
- 8 HATCHED PARTS: GROUND CIRCUIT.
 - SMT LEAD-COPLANARITY: 0.1 MAX.
 - THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - DO NOT MOUNT OTHER DEVICES ONTO AREA, OR MATING PAIR CANNOT BE MATED.
 - TO BE EMBOSSED CARRIER TAPED AS SPECIFIED IN SHEET 2.
 - THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

4	PHOSPHOR BRONZE	TIN-PLATING	2	COPPER ALLOY	CONTACT AREA: GOLD 0.1 μm min.
3	PHOSPHOR BRONZE	TIN-PLATING			LEAD AREA: GOLD FLASH
1	LCP	BEIGE UL94V-0			UNDER PLATING: NICKEL 1 μm min.
NO.	MATERIAL	FINISH, REMARKS	NO.	MATERIAL	FINISH, REMARKS
CODE NO. (OLD)	CL	DRAWN	DESIGNED	CHECKED	APPROVED
		K. NAKAMURA	K. NAKAMURA	K. Ogawa	H. Okawa
		06.05.18	06.05.18	06.05.19	06.05.19
SCALE	5 : 1	DRAWING NO.	EDC3-152093-21	PART NO.	FX11LA-80P/8-SV(91)
UNITS	mm	CODE NO.	CL573-0003-0-91		1/2

TO
PCK

